

# **BLANK PAGE**



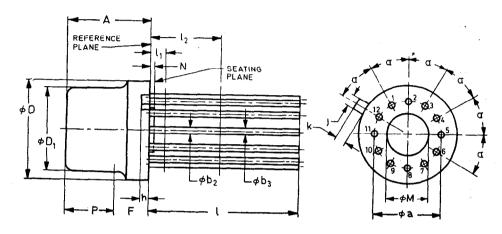


## Indian Standard

# DIMENSIONS OF SEMICONDUCTOR DEVICES DEVICE OUTLINE OD 28

#### 1. Dimensions

Note — This drawing has been prepared in accordance with IS:5001 (Part I) - 1969 'Guide for the preparation of drawings of semiconductor devices and integrated circuits: Part I Semiconductor devices 'and IS:5001 (Part II)-1973 'Guide for the preparation of drawings of semiconductor devices and integrated circuits: Part II Integrated circuits'.



Reference	Millimetres			Degrees Nom	Notes
	Min	Nom	Max	Nom	
A	6.10	_	6.60	_	
a	_	5-84*			1
b <sub>2</sub>	0.407	_	0.508		
b <sub>3</sub>	_	_	0.53		
D	8.64	_	9.39	_	_
D <sub>1</sub>	8:01	_	8.50	_	
F	2.54	_	_	_	_
-h	0.15	_	1.00	_	-
j	0.712	0.787	0.863		
k	0.74	_	1:14		2
/1	_		1.27	-	

\*Means true geometrical position.

(Continued)



Adopted 8 December 1978

@ July 1979, ISI

# IS: 5000 (OD 28) - 1978

Reference	Millimetres			Degrees Nom	Notes
-	Min	Nom	Max	Nom	
12	6.35	_	_	_	
1	12.70	_		_	_
М	3.56	_	4.06		_
N	0.26	_	1.01	_	
P	2:54			-	
α		_	_	30	1

Note 1 — The cross-section of each terminal at a distance  $l_1$  Max from the reference plane lies in a circle having a diameter of 0.99 mm centred at the true geometrical position defining the terminal axis at its point of exit.

Note 2 — Measured from the actual diameter D of the device.

Note 3 — The minimum axial length from seating plane beyond which the terminals may be bent at right angles is 3.8 mm.

Note 4 — One or more terminals may be omitted but the terminals position retains its number.

2. Rules for Coding — See 8.1 of IS: 5001 (Part I)-1969.

### 3. Equivalent Designation Code Followed by the Other Countries and Organizations

Country or Organization	Designation Code
India	OD28
IEC	_
USA	TO-101
France	TO-101/F96
Germany	5F12